

### **Review of EPL/501 legacy documents.**

The CSC provided a list of EPL/501 documents. Most of the documents are current and valid, but there are a number of possible anomalies which require discussion at the meeting on the 21<sup>st</sup> of April:

#### **BS 123000 series**

The following documents "*System of quality assessment. Generic specification. Printed boards*" etc do not appear to have been reviewed by EPL/501. Older BS ENs are still in force. Having been granted a derogation by CENELEC BT, these documents were originally developed by EPL/501 in order to replace the older EN / CECC documents (which are nonetheless still in use).

BSI Product Certification has confirmed that this series of documents are still in use by UK industry.

Recommendation – documents to be confirmed / remain current.

BS 123000:2001  
BS 123100-003:2001  
BS 123100:2001  
BS 123200-003:2001  
BS 123200:2001  
BS 123300-003:2001  
BS 123300:2001  
BS 123400-003:2001  
BS 123400:2001  
BS 123500-003:2001  
BS 123500:2001  
BS 123600-003:2001  
BS 123600:2001  
BS 123700-003:2001  
BS 123700:2001  
BS 123800-003:2001  
BS 123800:2001

#### **CECC / EN 123000 series**

The following documents "*System of quality assessment. Generic specification. Printed boards*" etc do not appear to have been reviewed by EPL/501. BSI Product Certification has confirmed that this series of documents are still in use by UK industry.

Recommendation – documents to remain current.

BS EN 123000:1992  
BS EN 123100:1992  
BS EN 123200:1992  
BS EN 123300:1992  
BS EN 123400-800:1992  
BS EN 123400:1992

BS EN 123500-800:1992  
BS EN 123500:1992  
BS EN 123600:1997  
BS EN 123700:1997  
BS EN 123800:1997  
BS CECC 23100-003:1996  
BS CECC 23100-801:1998  
BS CECC 23200-003:1996  
BS CECC 23200-801:1998  
BS CECC 23300-003:1996  
BS CECC 23300-801:1998  
BS CECC 23600-801:1998  
BS CECC 23700-801:1998  
BS CECC 23800-801:1998  
BS CECC 123400-003:1994  
BS CECC 123500-003:1994

#### **Others**

BS 4584-103.2:1990 (IEC 60249-3A:1976) *“Metal-clad base materials for printed wiring boards. Special materials used in connection with printed circuits. Specification for copper foil for use in the manufacture of copper-clad base materials”* has been replaced by BS EN 61249-5-1. Recommendation: withdraw.

BS 6221-1:1990 (IEC 60326-1:1984) *“Printed wiring boards. Guide for the specification writer”* and BS 6221-6:1982 (IEC 60326-6:1980) *“Printed wiring boards. Specification for multilayer printed wiring boards”* are both fragments of a superseded series of documents. Recommendation: withdraw.

BS CECC 200025:1998 *“Harmonized system of quality assessment for electronic components. Process assessment schedule: printed board assembly facilities”* is no longer required. Recommendation: withdraw.

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4<sup>th</sup> April 2016